

REMARKS

This is in response to the Office Action that was mailed on May 11, 2006. Claims 1-2, 4-14, and 16-18 are pending in this application. Claims 1, 13, 17, and 18 are amended to specify that the entire organic thin-film layer is transferred to the receiving surface of the first laminate. This amendment finds support for instance in the specification, page 16, line 20 through page 17, line 7. See also the transfer of transfer material 110 having an organic thin-film layer 112 formed on a temporary support 111 in Figure 1 of the drawings. No new matter is introduced by this Amendment.

THE INVENTION. Significant distinguishing features of the present invention include the steps of: peeling a temporary support from a laminate structure to transfer an entire organic thin-film layer to a receiving surface of the laminate; and bonding another laminate (which is a rear-surface electrode or a transparent conductive layer formed on a substrate) to the organic thin-film layer that was transferred onto the laminate structure. In the bonding step, heating is carried by a laminator, an infrared heater, or a roller heater.

Claims 1-16 were rejected under 35 U.S.C. §102(b) as being anticipated by US 6,194,119 B1 to Wolk et al. ("Wolk"). The Wolk patent corresponds to WO 00/41893, which is discussed on page 3 of Applicant's specification.

Wolk teaches a method for patterning a first material and a second material on a receptor – by selectively and simultaneously thermal transferring the first material proximate to the second material on the receptor donor, the first donor element comprising a substrate and a light-to-heat conversion layer disposed between the substrate and the first material and the first material – comprising selectively exposing the first donor element to imaging radiation. In Wolk, the materials can be coated onto thermal transfer donor elements to form

the transfer layers of the donor elements, and then the transfer layer materials can be patterned via selective thermal transfer from the donor to a receptor. Column 5, lines 48-50.

The Examiner acknowledges that Wolk transfers only a portion of the transfer material and Applicant transfers the entire pattern material of the organic film layer. Office Action, page 8. The claims herein have been amended to recite "transfer[ring] the entire organic thin-film layer to said receiving surface of said first laminate". It is respectfully submitted that specifying that the *entire* organic thin-film layer is transferred in this way overcomes the rejection of record. Withdrawal of the rejection, and passage of this application to Issue, is earnestly solicited.

If there are any questions, the Examiner is respectfully requested to contact Richard Gallagher (Reg. No. 28,781) at (703) 205-8008.

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Respectfully submitted,

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